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FCP190N60_GF102 N-Channel SuperFET[®] II MOSFET

600 V, 20.2 A, 199 m Ω

Features

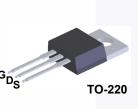
- 650 V @ T_J = 150°C
- Typ. R_{DS(on)} = 170 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 57 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 160 pF)
- 100% Avalanche Tested
- RoHS Compliant

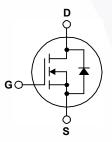
Application

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter			Unit	
V _{DSS}	Drain to Source Voltage			600	V	
		- DC	- DC - AC (f > 1 Hz)			
V _{GSS}	Gate to Source Voltage	- AC			V	
	Drain Gurrant	- Continuous (T _C = 25 ^o C)		20.2	•	
D	Drain Current	- Continuous (T _C = 100 ^o C)		12.7	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	60.6	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		400	mJ		
I _{AR}	Avalanche Current		(Note 1)	4.0	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)		2.1	mJ		
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P _D	Dower Discinction	(T _C = 25 ^o C)		208	W	
	Power Dissipation	- Derate Above 25°C		1.67	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TI	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C		

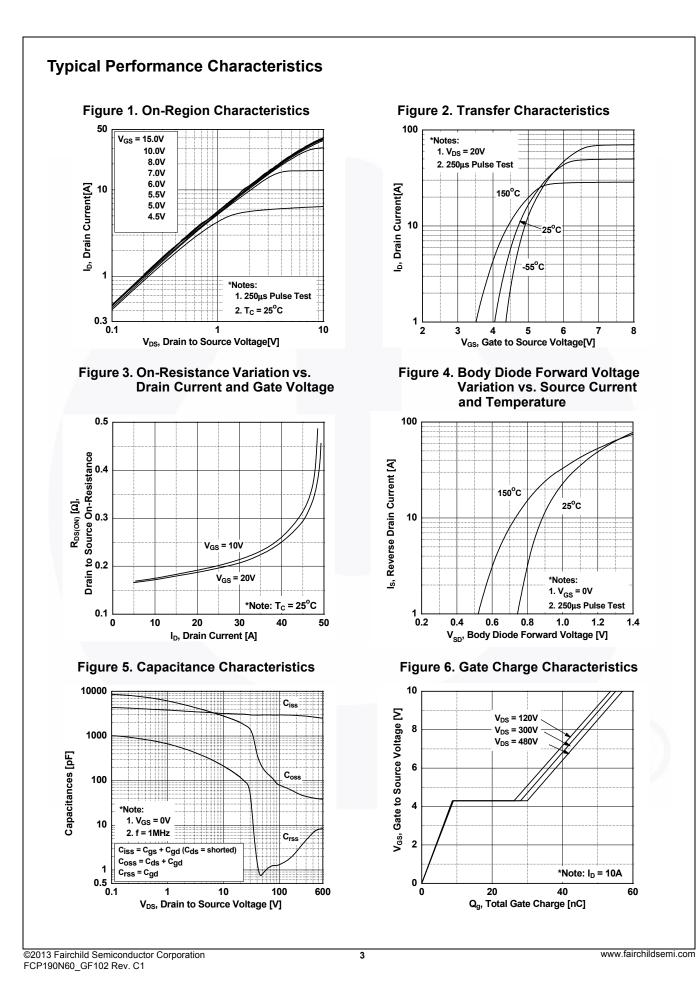
Thermal Characteristics

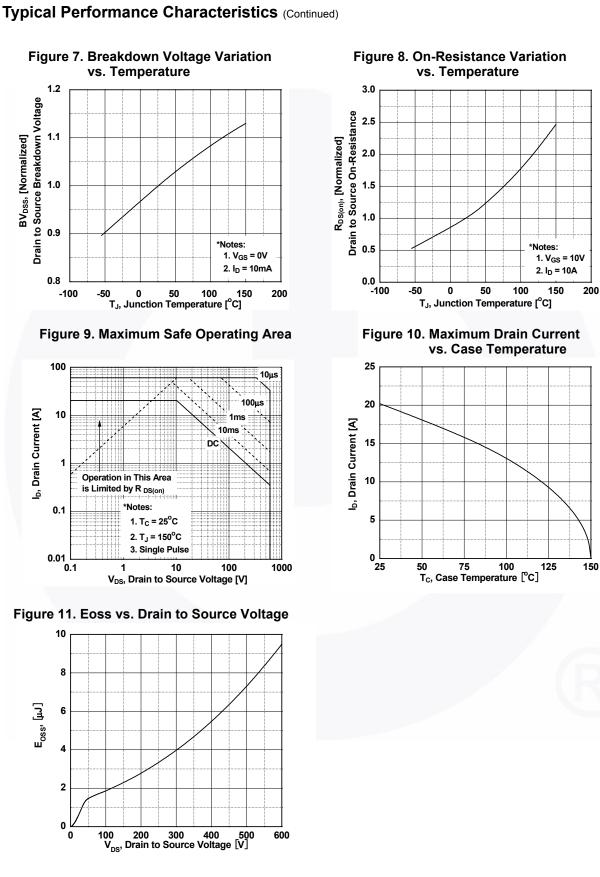
Symbol	Parameter	FCP190N60_GF102	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.6	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W	

FCP190N60_
GF102 — N-
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II MOSFET

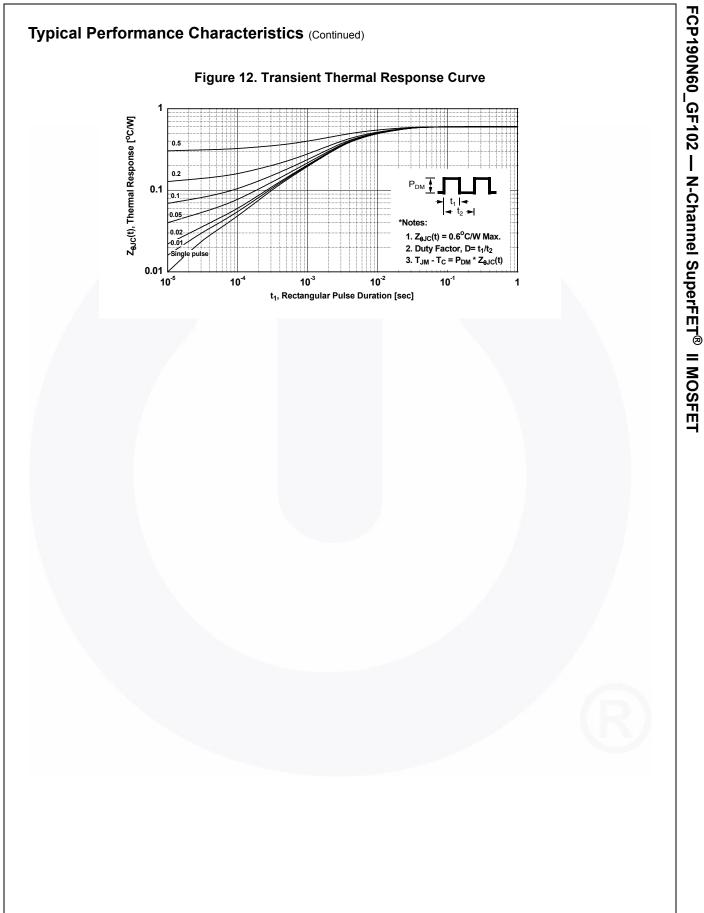
FCP190N60_	nber	Top Mark	Package	Packing Method	Reel Size	-	Tape Width	Qu	antity	
	_GF102	FCP190N60 GF102	TO-220	Tube	N/A		N/A	50	50 units	
Electrica	I Chara	acteristics T _C = 25°	C unless	otherwise noted.						
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit	
Off Charact	teristics	S								
			V	/ _{GS} = 0 V, I _D = 10 mA, T _J = 2	25°C	600	-	-		
BV _{DSS}	Drain to Source Breakdown Voltage			$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$		650	-	-	V	
ΔΒV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient			$I_D = 10 \text{ mA}, \text{ Referenced to } 25^{\circ}\text{C}$		-	0.67	-	V/ºC	
BV _{DS}	Drain to Source Avalanche Breakdown Voltage		down v	V _{GS} = 0 V, I _D = 20 A		-	700	-	V	
	Zero Gate Voltage Drain Current			/ _{DS} = 480 V, V _{GS} = 0 V		-	-	1	μA	
DSS				V_{DS} = 480 V, T_{C} = 125°C		-	-	10	μΑ	
I _{GSS}	Gate to	Body Leakage Current	V	V _{GS} = ±20 V, V _{DS} = 0 V		-	-	±100	nA	
On Charact	teristics	5								
V _{GS(th)}	Gate Th	reshold Voltage	V	′ _{GS} = V _{DS} , I _D = 250 μA		2.5	-	3.5	V	
R _{DS(on)}	-	rain to Source On Resista		r _{GS} = 10 V, I _D = 10 A		-	0.17	0.199	Ω	
9FS	Forward	Transconductance		r _{DS} = 20 V, I _D = 10 A		-	21	-	S	
Dynamic C	haracte	ristics								
C _{iss}		apacitance				- 1	2220	2950	pF	
C _{oss}	-	Capacitance		$V_{\rm DS} = 25 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V},$		-	1630	2165	pF	
C _{rss}	Reverse	Transfer Capacitance	T	= 1 MHz		-	85	128	pF	
C _{oss}	Output 0	Capacitance	V	/ _{DS} = 380 V, V _{GS} = 0 V, f = 1	MHz	-	42	-	pF	
C _{oss(eff.)}	Effective	e Output Capacitance	V	$V_{\rm DS}$ = 0 V to 480 V, $V_{\rm GS}$ = 0	V	-	160	-	pF	
Q _{g(tot)}	Total Ga	te Charge at 10V	V	/ _{DS} = 380 V, I _D = 10 A,		-	57	74	nC	
Q _{gs}	Gate to	Source Gate Charge	V	/ _{GS} = 10 V		-	9	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge			(Note 4)	-	21	-	nC	
ESR	Equivale	ent Series Resistance	f	= 1 MHz		-	1	-	Ω	
Switching	Charact	teristics								
t _{d(on)}	Turn-On	Delay Time				-	20	50	ns	
t _r	Turn-On	Rise Time	V	/ _{DD} = 380 V, I _D = 10 A,		-	10	30	ns	
	Turn-Off	Delay Time	V	V_{GS} = 10 V, R_g = 4.7 Ω		-	64	138	ns	
		Fall Time			(Note 4)	-	5	20	ns	
t _{d(off)} t _f	Turn-Off									
t _{d(off)} t _f		le Characteristics								
t _{d(off)} t _f Drain-Sour	ce Dioc	le Characteristics	urce Diod	e Forward Current		-	-	20.2	Α	
t _{d(off)} t _f Drain-Sour I _S	ce Dioc Maximur					-	-	20.2 60.6	A A	
t _{d(off)} t _f Drain-Sour	rce Dioc Maximur Maximur	m Continuous Drain to Sou	Diode Fo							
t _{d(off)} t _f Drain-Sour Is I _{SM}	Ce Dioc Maximur Maximur Drain to	m Continuous Drain to Sou m Pulsed Drain to Source	Diode For	rward Current				60.6	А	

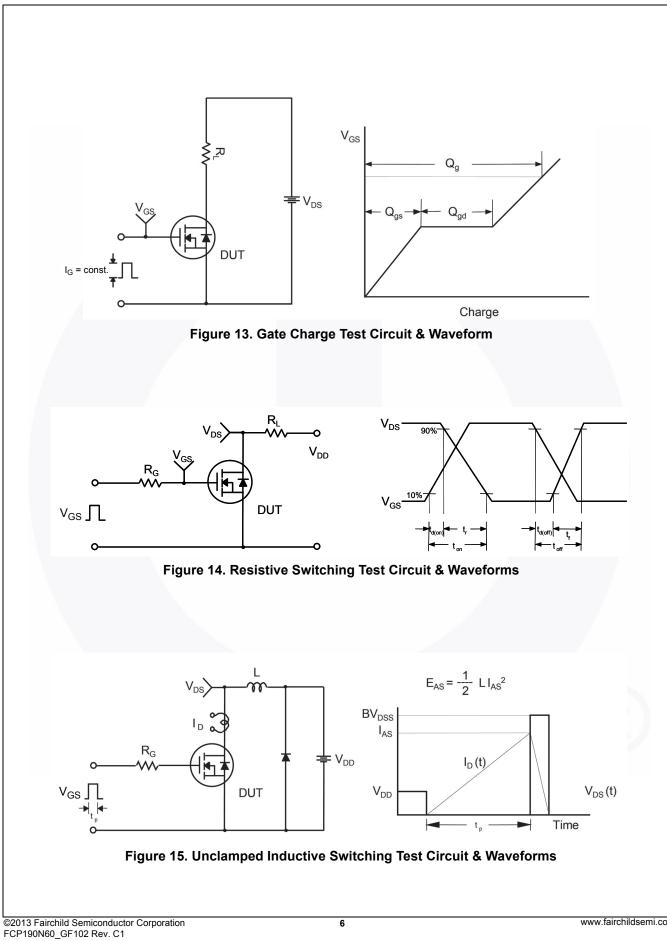
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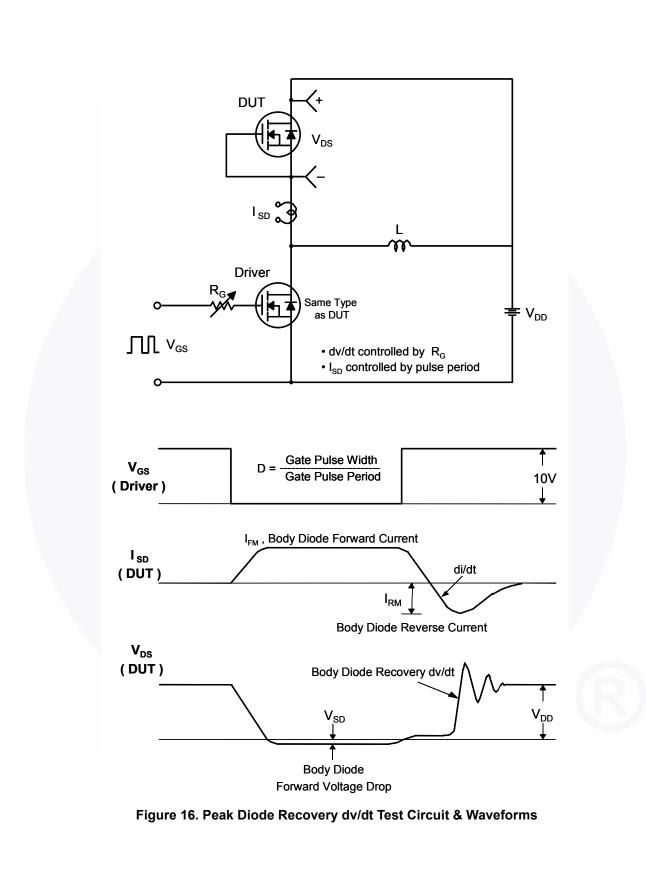
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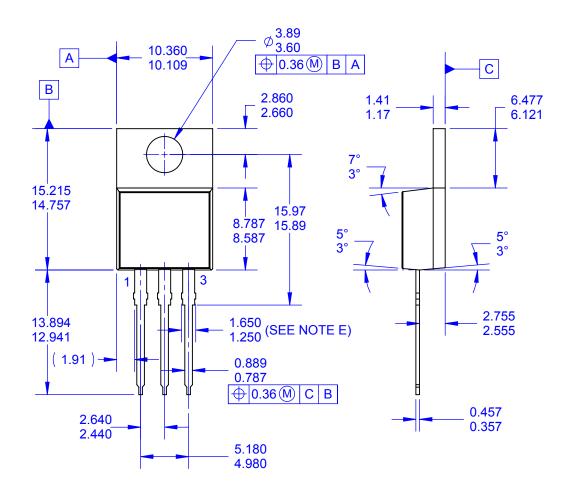


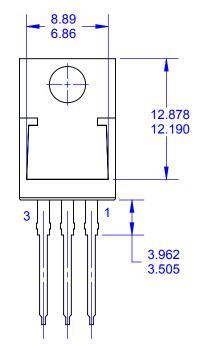
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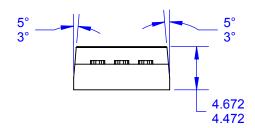
FCP190N60_GF102 — N-Channel SuperFET[®] II MOSFET



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NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220 VARIATION AB
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. MAX WIDTH FOR F102 DEVICE = 1.35mm. F. DRAWING FILE NAME: TO220T03REV4.
- G. FAIRCHILD SEMICONDUCTOR.

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